# RENESAS

## IML3112

I3C Basic 1:2 Bus Multiplexer

## Description

The IML3112 is a dual bidirectional 1:2 translating multiplexer for I3C/I<sup>2</sup>C bus. The input HSDA/HSCL pair can fan out to two output pairs (or channels), either individual output channel can be selected.

Applications with slave devices that share the same address can use this multiplexer to prevent slave address conflicts. By selecting the proper output channel, the I3C/I<sup>2</sup>C master can access a large number of devices across both ports.

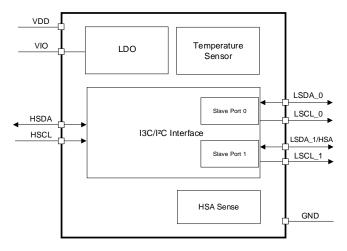


Figure 1. Block Diagram

### Features

- 1:2 bus multiplexer
- Two-wire programmable I<sup>2</sup>C or I3C bus serial interface
- Single device load on the Host bus
- Up to 12.5MHz transfer rate
- Single 1.8V power supply input
- 1.0V VLDO output at VIO pin
- Push-pull IO levels:
  - 。 Host bus: 1.8V
  - $_{\circ}~$  Local bus: 1.0V, 1.1V, 1.2V, and 1.8V
- · Open-drain IO levels:
  - $_{\circ}~$  Host bus: 1.8V, 2.5V and 3.3V
  - Local bus: 1.0V, 1.1V, 1.2V,1.8V, 2.5V, and 3.3V
- Integrated Temperature Sensor; 0.5°C accuracy with 0.25°C resolution
- Packet Error Check (PEC) function
- Parity Error Check function
- · Bus reset function
- In-band Interrupt (IBI)
- · Up to 8 unique addressing
- Programmable I<sup>2</sup>C, I3C bus addressing scheme
- 9-pin thermally enhanced DFN package
- Temperature: Industrial range of -40 °C to 125°C

## Applications

- Pin reduction in host or ASIC or platform controllers
- · Server boards
- · PCs/notebooks
- · Embedded automation

#### IMPORTANT NOTICE AND DISCLAIMER

RENESAS ELECTRONICS CORPORATION AND ITS SUBSIDIARIES ("RENESAS") PROVIDES TECHNICAL SPECIFICATIONS AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, WITHOUT LIMITATION, ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for developers skilled in the art designing with Renesas products. You are solely responsible for (1) selecting the appropriate products for your application, (2) designing, validating, and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. Renesas grants you permission to use these resources only for development of an application that uses Renesas products. Other reproduction or use of these resources is strictly prohibited. No license is granted to any other Renesas intellectual property or to any third party intellectual property. Renesas disclaims responsibility for, and you will fully indemnify Renesas and its representatives against, any claims, damages, costs, losses, or liabilities arising out of your use of these resources. Renesas' products are provided only subject to Renesas' Terms and Conditions of Sale or other applicable terms agreed to in writing. No use of any Renesas resources expands or otherwise alters any applicable warranties or warranty disclaimers for these products.

(Rev.1.0 Mar 2020)

#### **Corporate Headquarters**

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

#### Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

#### **Contact Information**

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit: www.renesas.com/contact/